

# 3A, 50V - 1000V Fast Recovery Surface Mount Rectifier

### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Fast switching for high efficiency
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### **APPLICATIONS**

- DC to DC converter
- Switching mode converters and inverters
- Lighting application
- Snubber
- General purpose

### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS				
PARAMETER	PARAMETER VALUE UNI			
١ <sub>F</sub>	3	А		
V <sub>RRM</sub>	50 - 1000	V		
I <sub>FSM</sub>	100	А		
T <sub>JMAX</sub>	150	°C		
Package DO-214AB (SMC)				
Configuration	Single die			
Ph DUS HALOGEN				



KOH2

DO-214AB (SMC)



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)									
PARAMETER	SYMBOL	RS3A	RS3B	RS3D	RS3G	RS3J	RS3K	RS3M	UNIT
Marking code on the device		RS3A	RS3B	RS3D	RS3G	RS3J	RS3K	RS3M	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub>	3					Α		
Peak forward surge current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	I <sub>FSM</sub> 100				A			
Junction temperature	TJ	T <sub>J</sub> - 55 to +150			°C				
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C				



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-lead thermal resistance	R <sub>eJL</sub>	15	°C/W		
Junction-to-ambient thermal resistance	R <sub>eja</sub>	50	°C/W		

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT	
Forward voltage <sup>(1)</sup>		$I_F = 3A, T_J = 25^{\circ}C$	V <sub>F</sub>	-	1.3	V	
Reverse current @ rated $V_R^{(2)}$		$T_J = 25^{\circ}C$	I <sub>R</sub>	-	10	μA	
		T <sub>J</sub> = 125°C		-	250	μA	
Reverse recovery time	RS3A RS3B RS3D RS3G	I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1.0A,	t <sub>rr</sub>	t	-	150	ns
	RS3J	I <sub>rr</sub> = 0.25A		-	250	ns	
	RS3K RS3M			-	500	ns	

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
RS3x	DO-214AB (SMC)	3,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 50V(RS3A) to 1000V(RS3M)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

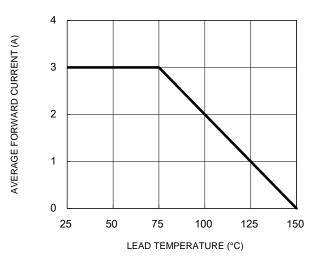
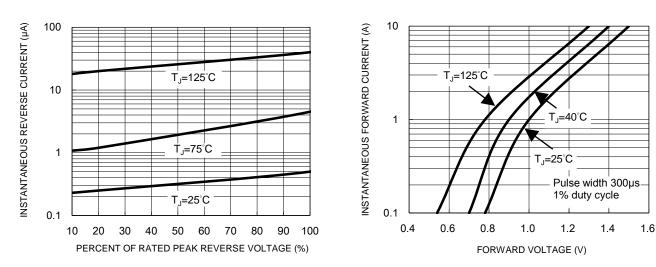
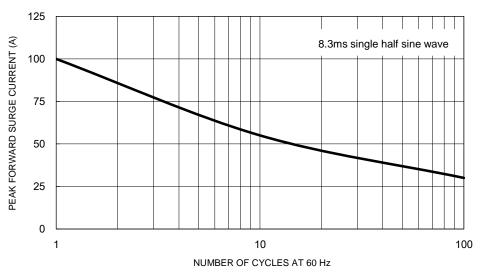


Fig.1 Forward Current Derating Curve

#### Fig.3 Typical Reverse Characteristics





#### Fig.5 Maximum Non-Repetitive Forward Surge Current

1000

100

10

1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

Fig.2 Typical Junction Capacitance

10

REVERSE VOLTAGE (V)

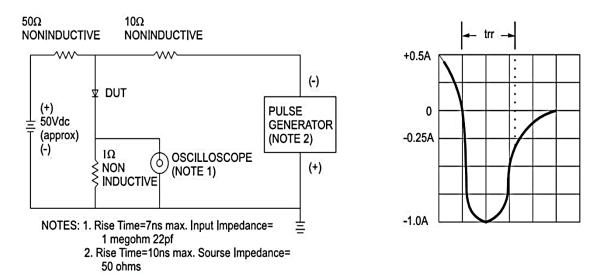
**Fig.4 Typical Forward Characteristics** 

100



## **CHARACTERISTICS CURVES**

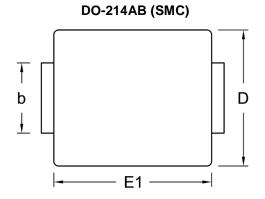
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

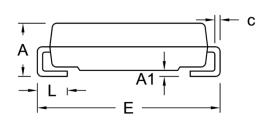


#### Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram



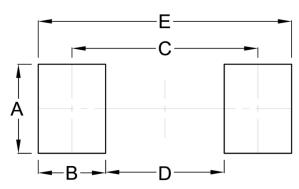
# PACKAGE OUTLINE DIMENSIONS





DIM.	Unit	(mm)	Unit (inch)		
	Min.	Max.	Min.	Max.	
A	2.00	2.62	0.079	0.103	
A1	0.10	0.20	0.004	0.008	
b	2.90	3.20	0.114	0.126	
с	0.15	0.31	0.006	0.012	
D	5.59	6.22	0.220	0.245	
E	7.75	8.13	0.305	0.320	
E1	6.60	7.11	0.260	0.280	
L	1.00	1.60	0.039	0.063	

# SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

# **MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound

YW = Date Code

F = Factory Code



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